

# S092P OPS-C PC Module v1.0

Equipped with Intel 11th generation Core Tigerlake-H processor and Intel HM570 chipset, 80pin support up to 4K@60HZ resolution output, providing quality hardware and arithmetic support for education/conference large screen. Built-in high-performance graphics card, wireless module, support gigabit network, to ensure high-definition image display, stable network, to further enhance the use of large screen and display experience.

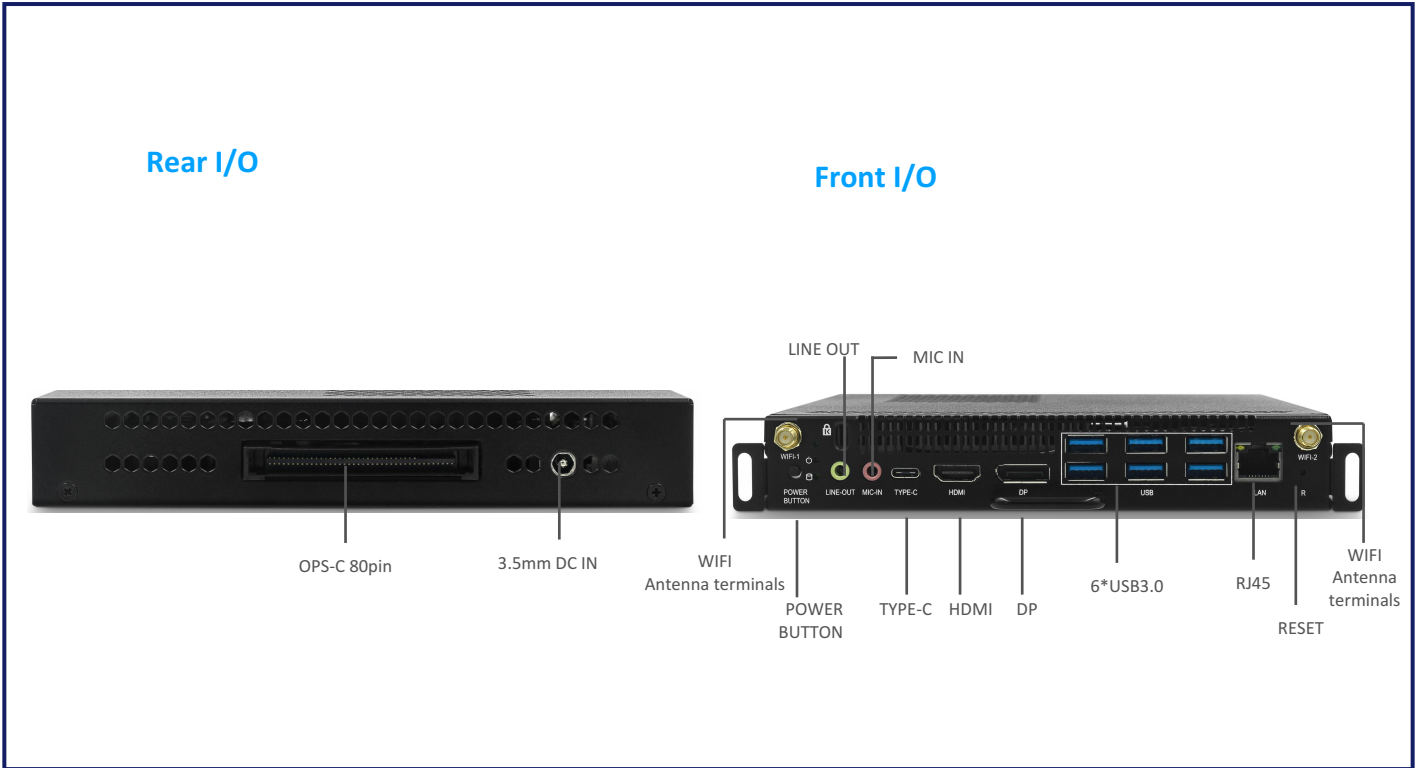


- Intel TGL-H platform
- Intel®OPS-C Standard Module
- Support Dual SO-DIMM DDR4
- Support Dual M.2 2280 SSD Module
- Support HDMI 2.0
- Support M.2 2230 WiFi Module
- 80-pin connection
- Support DP 1.2

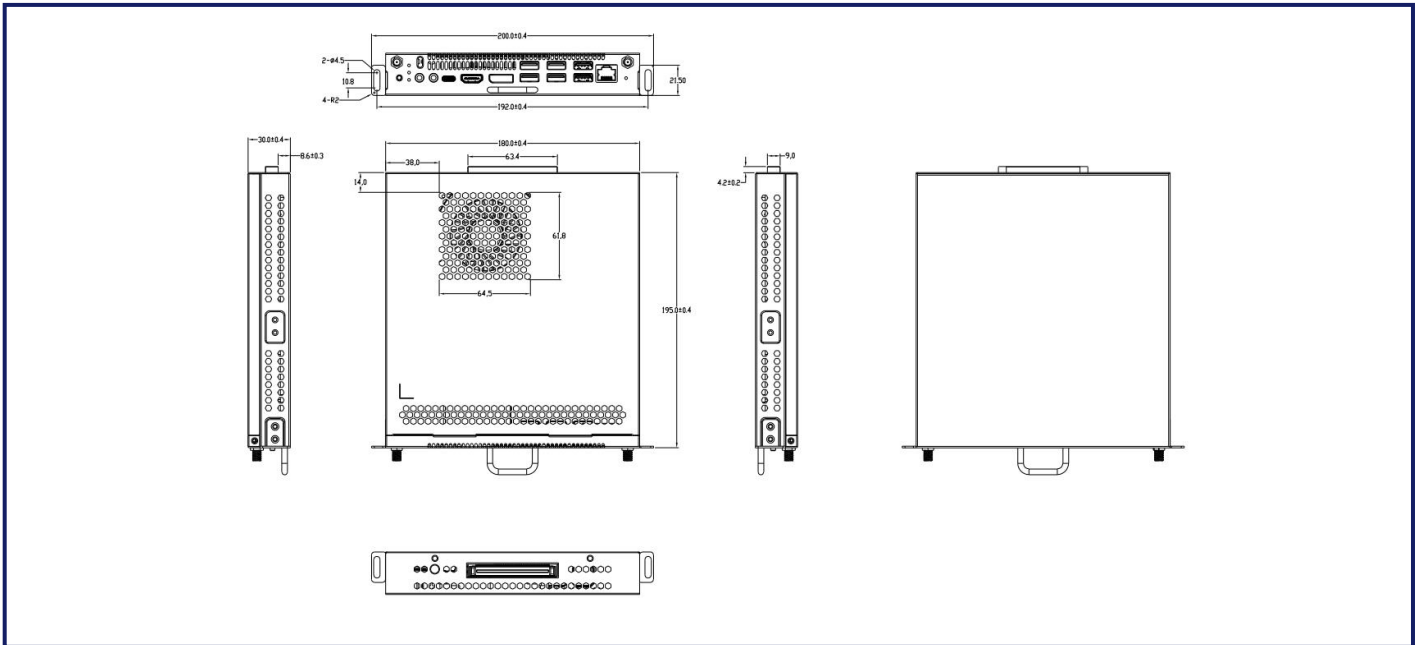
## 01 Specifications

	CPU	Intel® TigerLake-H, TDP. 35W
	Chipset	HM570
	BIOS	AMI UEFI BIOS
	Processor Graphics	Intel® Iris® Xe Graphics eligible
	Multi displays	3
	Interface	1 x DP1.2, 1 x HDMI 1.4, 1 x HDMI 2.0 ( 80pin)
	Type	2 x SO-DIMM DDR4 3200 MHz
	Max	32GB
	Lan IC	RTL8111H
	Interface	10/100/1000Mbps
	Connector	1 x RJ45
		Realtek ALC897 HD Audio IC
	Type	Wi-Fi/BT module
	Interface	1 x M.2 2230
	Type	SSD
	Interface	1 x M.2 2280, Nvme/SATA 1 x M.2 2280, Nvme(Optional)
	Front panel	1 x USB3.0 Type-C 6 x USB3.0 Type-A 1 x RJ45 10/100/1000M 1 x HDMI 1.4 out, Max.4K/30Hz 1 x DP1.2 out , Max.4K/60Hz 1 x 3.5mm Line out 1 x 3.5mm Mic in 2 x WIFI/BT ANT 1 x Power button 1 x Recover button 1 x Power LED 1 x SSD LED
	Rear panel	OPS-C 80pin: 1xHDMI2.0 , 2 x USB2.0 , 1 x USB3.0 , TTL 3.5mm DC IN
	OS Supports	WINDOWS 10/WINDOWS 11
	Watchdog	Support
	vPro/AMT	No
	TPM	Optional
	Power input	12-19V DC IN
		Comply with ops-c standard module , 195(L) x 180(W) x 30(H) mm
	NW	1.31 kg
	GW	1.58 kg
	Operating Temp.	-10°C~50°C
	Operating Humidity	10%~95% non-condensing

02 Product view



03 Dimensions



04 Order Information

S092PT	1*HDMI 2.0/1*USB3.0 Type-C+6*USB3.0 Type-A/1*DP1.2/RTL8111H Lan IC/ALC897 HD Audio IC
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